## 502703522 03/03/2014

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:		NEW ASSIGNMENT	NEW ASSIGNMENT			
NATURE OF CONVEYANCE:		ASSIGNMENT	ASSIGNMENT			
CONVEYING PART	Y DATA					
Name			Execution Date			
SEUNG-HWAN PARK			02/25/2014			
HYUNG-NAM JIN		02/25/2014				
RECEIVING PARTY	DATA					
Name:	MAGNACHIP	MAGNACHIP SEMICONDUCTOR, LTD.				
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City:	CHEONGJU-	CHEONGJU-SI				
State/Country:	KOREA, REP	KOREA, REPUBLIC OF				
PROPERTY NUMBE	ERS Total: 1					
Property Type		Number				
Application Number:		14195191				
CORRESPONDENC	CE DATA					
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Total Attachments: 2

Signature:

Date:

ATTORNEY DOCKET NUMBER:

NAME OF SUBMITTER:

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PATENT 502703522 REEL: 032337 FRAME: 0348

023117.0003

03/03/2014

GEORGE N. PHILLIPS

/George N. Phillips/

Attorney Docket No.: 023117.0003

## COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

## DECLARATION

As a below-named inventor, I hereby declare that this declaration is directed to the application attached
hereto, or to United States Application Number or PCT International Application Number
filed on(if applicable), entitled:
METHOD OF SENSING FLIP COVER
The above-identified application was made or authorized to be made by me.
I believe I am the original inventor or an original joint inventor of a claimed invention in the above-identified application.
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.
I have reviewed and understand the contents of the above-identified application, including the claims.
I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information that became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.
ASSIGNMENT
For valuable consideration, I, as a below-named assignor, hereby assign to:
Magnachip Semiconductor, Ltd.  1, Jikji-daero 307beon-gil, Heungdeok-gu Cheongju-si, Chungcheongbuk-do, 361-725 Republic of Korea
and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title, and
interest throughout the world in the inventions and improvements that are the subject of the application
identified in the above declaration, which is United States Application Number or PCT International
Application Number 14/195,191 filed on March 3, 2014
I authorize and request the attorneys appointed in the above-identified application to hereafter complete this Assignment by inserting above the application number and the filing date of the above-identified

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Attorney Docket No.: 023117.0003

application when known, and to correct any typographical errors that may be discovered in this Assignment.

This Assignment includes the above-identified application, any and all United States and foreign patents, utility models, and design registrations granted for any of the inventions and improvements that are the subject of the above-identified application, and the right to claim priority based on the filing date of the above-identified application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

Inventor's Legal Name	Seung-hwan PARK				
Inventor's Signature	bligge	Date	TEB. 25. 2014		
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Inventor's Legal Name	Hyung-nam JIN				
Inventor's Signature	大	Date	Feb. 25, 2014		
Residence (City, Country)	Sejong-si, Republic of Korea				
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RECORDED: 03/03/2014